

Modeling Grain Boundary Structure and Mechanical Properties using LAMMPS* with EAM Potentials

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*Some calculations done with WARP



Constructing GB Models

- Grain boundary modeling
 - Bicrystal models allow for "isolation" of specific mechanisms
 - Nanocrystalline models allow for an analysis of triple junctions and deformation constrains imposed by opposing grains



Spearot and McDowell (2009)

- Relevant LAMMPS commands
 - Bicrystal: region, lattice, orient, origin, delete_atoms (overlap)
 - Polycrystalline: read_data (created in matlab)



Grain Boundary Structures

- Energy minimization
 - Steepest decent or conjugate gradient method
 - Multiple starting positions must be used to probe energy landscape







Σ11 (113) 50.5°

Mills et al. (1992); Medlin et al. (1993)





Σ9 (221) 141.1° Spearot (2005)

- Relevant LAMMPS commands
 - minimize, min_style, min_modify



Controlled Deformation Methods





- Emission of interface dislocations in bicrystals
 - > Σ 5 (310) <100> interface in aluminum
 - Calculations are performed at 10 K



A ledge is formed at the interface after the nucleation of the trailing partial dislocation without atomic shuffling along the interface plane

Spearot et al., Acta Materialia (2005)



• Stress required for dislocation nucleation

Symmetric tilt copper <100> bicrystal interface models



Spearot et al. (2007) Acta Materialia, 55, 705-714.



Plastic Deformation of NC Cu-Sb



Rajgarhia et al. (2010) Journal of Materials Research, in press.



• Nanocrystalline Cu with Sb at grain boundaries

Uniaxial tensile deformation at 300 K



Small concentrations of Sb at the grain boundaries increases the flow stress, but does not shift the grain diameter associated with peak strength

Rajgarhia et al. (2010) Journal of Materials Research, in press.



- Rendering / moving large dump files
 - Ensight (<u>www.ensight.com</u>)
 - Ovito (<u>www.ovito.org</u>) still beta release
 - Paraview (<u>www.paraview.org</u>) distributed rendering at TACC
- Modeling triple junctions
 - Incompatibility with "classical" periodic boundary conditions?
 - May require flexible border boundaries (Cai et al., Kurtz et al.)
- Linking bicrystal and nanocrystalline data
 - Incorporating bicrystal properties/mechanics into constitutive models for polycrystalline behavior
 - Sampling and statistics? (Foiles, Olmsted and Holm)

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